IPC ASSOCIATION CONNI	© Copyright 2005. I	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both This docu	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Materi					ials and Mfc Information			
upplier Info	ormation								· · · ·	U				
Company name*			Company unique ID			Unique ID Authority				Response Date*				
nsemi											2024-05-16			
Contact Name			Title - Contact			Phone - Contact*				Email - Contact*				
Product-Env-St	Stewards		Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com			
uthorized Rep	presentative*		Title - Representative			Phone - Rep	Phone - Representative*			Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			NA	, NA			Product-Env-Stewards@onsemi.com				
Requ	Requester Item Number		Mfr Item Number Mfr Item Name			Effective D	ate Ve	ersion	Manufacturing Site	Weigh	ht*	UOM	Unit Type	
		NCP51403MNTXG 3 Amp VTT Termir DDR2, DDR3, LPD		nation Regulator DDR1, DDR3, DDR4	2024-05-16		MY1		25.0		mg	Each		
Ianufacturi	ing Proccess Informa	tion												
Terminal Plating / Grid Array Material Terminal Base Alloy			Alloy J-	STD-020 MSL Rating	ASL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycles						es			
Matte Tin (Sn) - annealed C		CU Alloy 1			260	260 C 30		seconds	3					
omments														
vel 1 - maximu	um time at peak temperat	ure during sol	dering is 10-3	30 seconds										
or more inform	mation regarding material	composition	please refer t	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier supplier has not independently verified information provided by others, supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.52	mg	Supplier	Silicon (Si)	7440-21-3		1.52	mg
Die Attach	0.22	mg	Supplier	Silver (Ag)	7440-22-4		0.165	mg
			Supplier	Epoxy resins	129915-35-1		0.055	mg
Lead Frame	10.17		Supplier	Silver (Ag)	7440-22-4		0.1017	mg
			Supplier	Tin (Sn)	7440-31-5		0.0254	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0224	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0254	mg
			Supplier	Copper (Cu)	7440-50-8		9.9951	mg
Mold Compound-Black	12.43			Epoxy resin	proprietary data		0.5842	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1.243	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0124	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		10.0062	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.5842	mg
Plating	0.47	mg	Supplier	Tin (Sn)	7440-31-5		0.47	mg
Wire Bond - Au	0.19	mg	Supplier	Gold (Au)	7440-57-5		0.19	mg